DATA	SHEET		
PART NO.: L	C101WDT 5		
FARI NO L	-C191 W D1-J	9 A- 01	
REV:	A/2		
CUSTOMER'S APPROVAL :		<u>DCC :</u>	1.010
DRAWING NO. : DS-74-17-0011G	DATE : 2021-11-11	Page	1 of 13 LD-R/R005

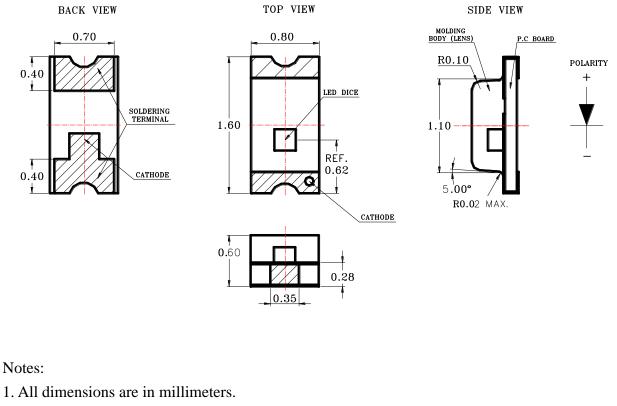
Part No.: L-C191WDT-5A-U1

REV: A / 2

• Features

- * Extra thin 0.6mm, Top view, Wide view angle, White color SMD chip LED .
- * Special for Cellular Phone keypad / LCD backlighting or thin touch button LED backlighting.
- * Packing in 8mm tape on 7" diameter reels.
- * Compatible with automatic Pick & Place equipment.
- * Compatible with Reflow soldering and Wave soldering processes.
- * EIA STD package.(ANSI/EIA-481-B-2001)
- * I.C. compatible, low current application
- * Pb free product and acceptable lead-free process!.
- * Meet RoHS Green Product.
- * MSL-3

PACKAGE OUTLINE DIMENSIONS



2. Tolerance is \pm 0.1mm (.004") unless otherwise noted.

Part No.: L-C191WDT-5A-U1

REV: A/2

• CHIP MATERIALS

- * Dice Material : InGaN
- * Light Color : White
- * Lens Color : Light Green Diffused.

• Absolute Maximum Ratings(Ta=25°C)

Symbol	Parameter	Rating	Unit
PD	Power Dissipation	100	mW
IPF	Peak Forward Current	80	mA
	(1/10 Duty Cycle, 0.1ms Pulse Width)		
IF	Continuous Forward Current	20	mA
-	De-rating Linear From 25°C	0.25	mA/℃
VR	Reverse Voltage	5	V
ESD	Electrostatic Discharge Threshold(HBM)Note A	1000	V
Topr	Operating Temperature Range	-40 ~ + 85	°C
Tstg	Storage Temperatur Range	-40 ~ + 85	°C

Note A :

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

• Electro-Optical Characteristics(Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition	
Luminous Intensity	IV	180	280	710	mcd	IF=5mA	
Viewing Angle	2 0 1/2		130		Deg	Note 2	
CIE Chromaticity	X		0.28			IF=5mA	
CIE Chromaticity	Y		0.28				
Forward Voltage	VF	2.50	2.70	2.9	V	IF = 5mA	
Reverse Current	IR			50	μA	VR = 5V	

DRAWING NO. : DS-74-17-0011G

DATE : 2021-11-11 PAGE 3 of 13

Part No.: L-C191WDT-5A-U1

REV: A/2

• Bin Code List

Luminous Intensity(IV), Unit:mcd@5mA						
Bin Code	Min	Max				
S	180	280				
Т	280	450				
U	450	710				

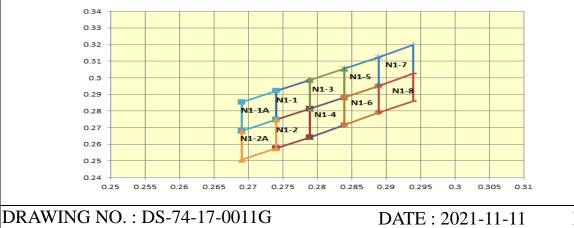
Forward Voltage(VF), Unit:V@5mA						
Bin Code	Min	Max				
10	2.50	2.60				
11	2.60	2.70				
12	2.70	2.80				
13	2.80	2.90				

Tolerance of each bin are $\pm 15\%$

Tolerance of each bin are±0.1Volt

Color Rank (CIE chromaticity X, Y) @ 5mA									
Rank N1-1A			Rank N1-2A						
Х	0.274	0.269	0.269	0.274	Х	0.269	0.269	0.274	0.274
Y	0.2921	0.2854	0.2681	0.2748	Y	0.2681	0.2508	0.2575	0.2748
Rank N1-1				Rank N1-2					
X	0.274	0.274	0.279	0.279	Х	0.274	0.274	0.279	0.279
Y	0.2921	0.2748	0.2815	0.2988	Y	0.2748	0.2575	0.264	0.2815
Rank N1-3			Rank N1-4						
Х	0.279	0.279	0.284	0.284	Х	0.279	0.279	0.284	0.284
Y	0.2988	0.2815	0.2882	0.3055	Y	0.2815	0.264	0.2715	0.2882
Rank N1-5				Rank N1-6					
X	0.284	0.284	0.289	0.289	Х	0.284	0.284	0.289	0.289
Y	0.3055	0.2882	0.295	0.3123	Y	0.2882	0.2715	0.279	0.295
Rank N1-7				Rank N1-8					
Х	0.289	0.289	0.294	0.294	Х	0.289	0.289	0.294	0.294
Y	0.3123	0.295	0.3025	0.3198	Y	0.295	0.279	0.286	0.3025

LC191WDT-5MA白光案



PAGE 11 of 13

Part No.: L-C191WDT-5A-U1

REV: A / 2

Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
- 2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Caution in ESD :

Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

4. Major standard testing equipment by "Instrument System" Model : CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model : 2400.

Typical Electro-Optical Characteristics Curves

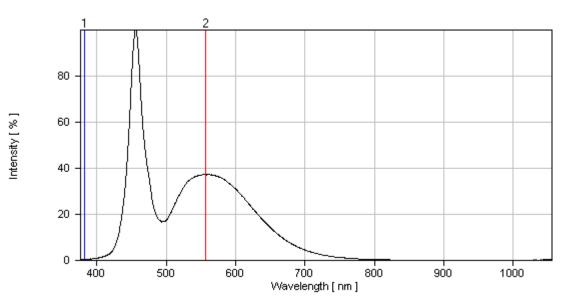
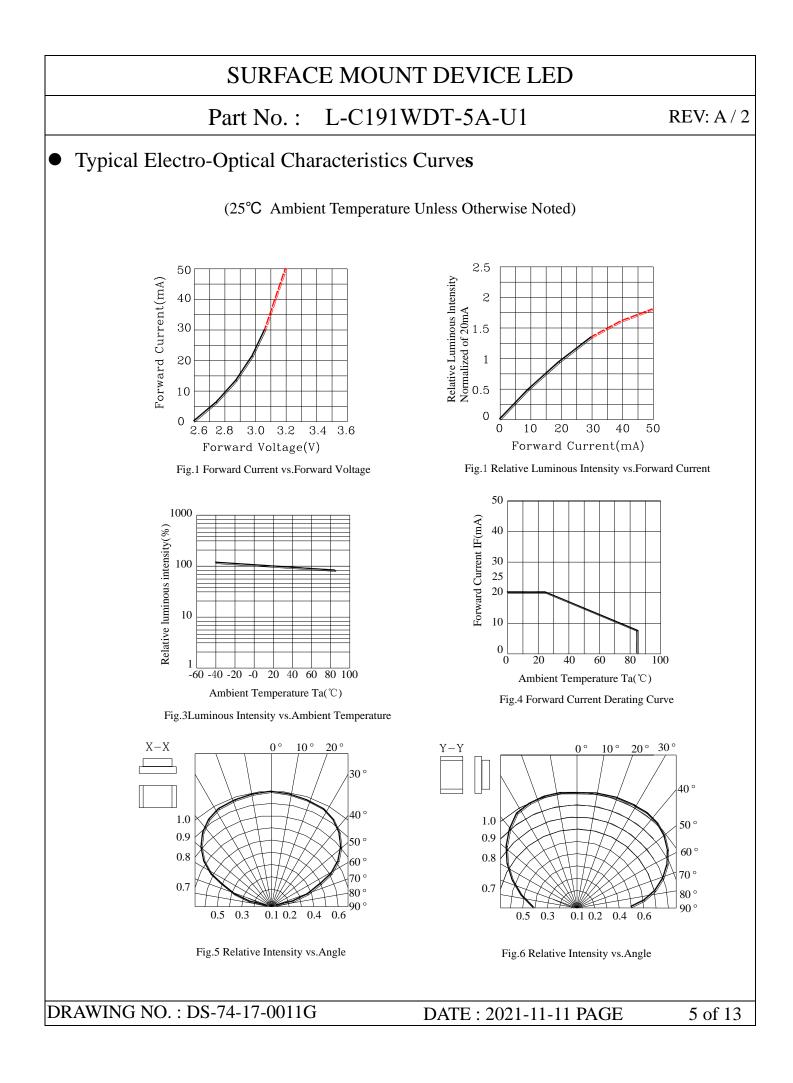


Fig.1 Relative Intensity vs. Wavelength

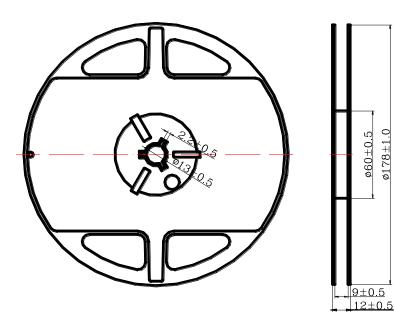


SURFACE MOUNT DEVICE LED Part No.: L-C191WDT-5A-U1 REV: A/2• Label Explanation CUS.PART NO: CUSTOMER: PART NO: IV: LOT NO: VF: CIE: QUANTITY: QC: DATE CODE: RoHS ITEM CODE:PARA LIGHT PART NO: L-C191WDT-5A-U1 IV --- Luminous Intensity Code LOT NO: EM S 09 0110 L F А В С D Е A---EM: Emos Code B---S:SMD L---Local D---Year E---Month F---SPEC. PACKING QUANTITY OF BAG: 3000pcs for 150, 170, 110, 155, 115 series 4000pcs for 191 series 5000pcs for 192 series DATE CODE: <u>2012</u> <u>09</u> <u>10</u> G Η Ι G--- Year H---- Month I --- Day DRAWING NO. : DS-74-17-0011G DATE : 2021-11-11 PAGE 6 of 13

Part No.: L-C191WDT-5A-U1

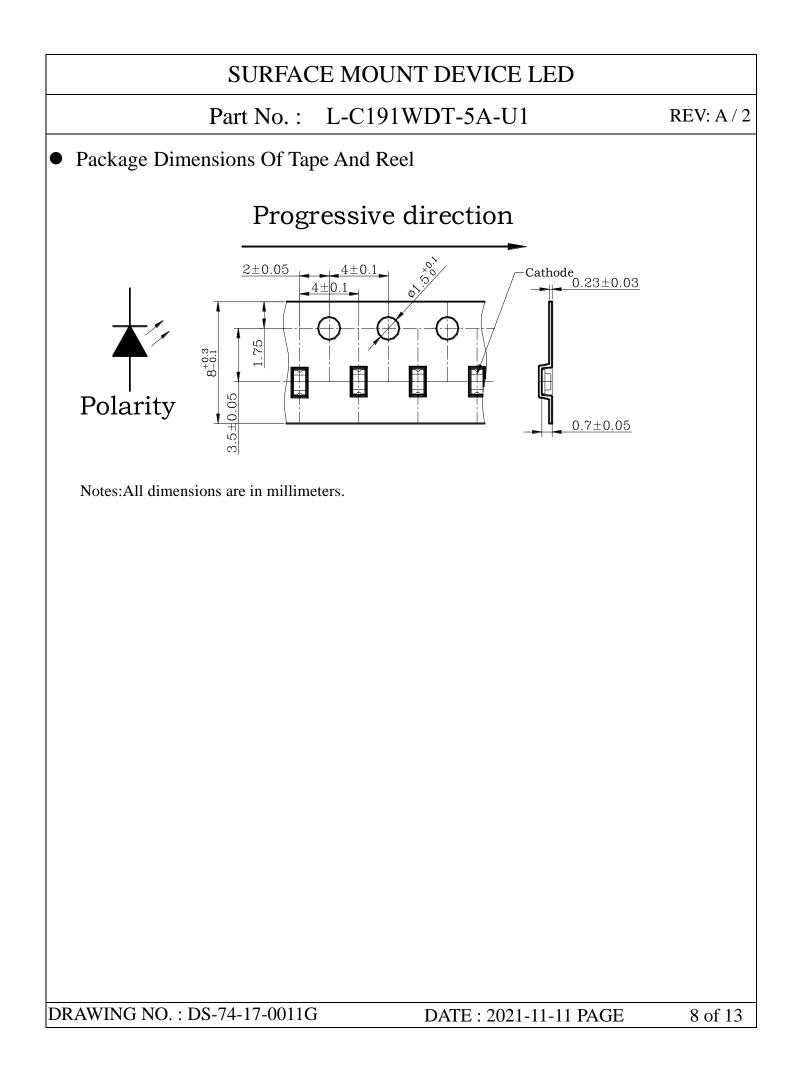
REV: A / 2

• Reel Dimensions



Notes:

- 1. Taping Quantity : 3000pcs
- 2. The tolerances unless mentioned is $\pm 0.1 \text{mm}$, Angle $\pm 0.5^\circ\,$, Unit : mm.



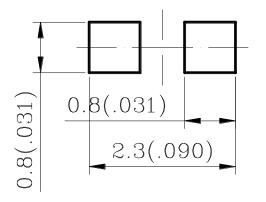
Part No.: L-C191WDT-5A-U1

REV: A / 2

• Cleaning

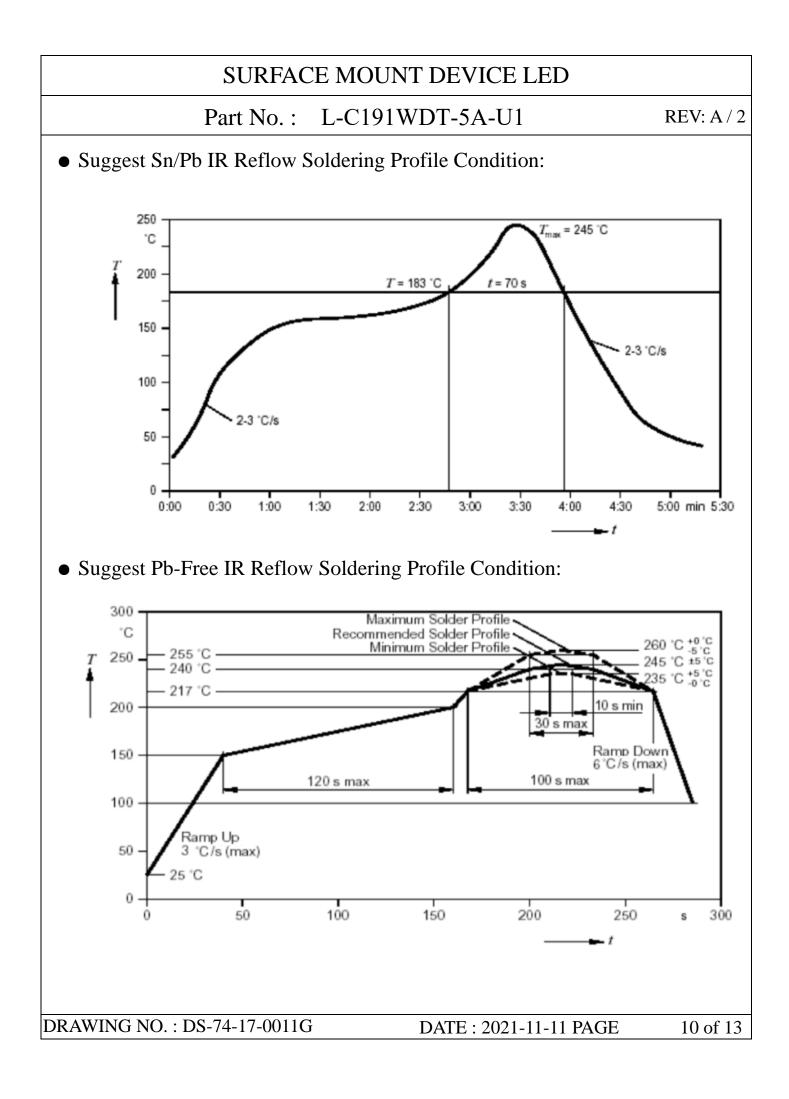
- * If cleaning is required, use the following solutions for less than 1 minute and less than 40° C.
- * Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

• Suggest Soldering Pad Dimensions



Direction of PWB camber and go to reflow furnace

Notes : Suggest stencil print screen thickness are 0.10mm maximum.



Part No. : L-C191WDT-5A-U1

REV: A / 2

CAUTIONS

1. Application Limitation :

The LED's described here are intended to be used for ordinary electronic equipment(such as office equipment, communication equipment and household application).Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage :

Do not open moisture proof bag before the products are ready to use.

Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: $60\pm5^{\circ}$ C for 24 hours.

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering condition.

Reflow Soldering :

Pre-heat 120~150 °C, 120sec. MAX., Peak temperature : 240 °C Max. Soldering time : 10 sec Max. Soldering Iron : (Not recommended)

Temperature 300 $^{\circ}$ C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering. Wave soldering :

Pre-heat 100 $^{\circ}$ C Max, Pre-heat time 60 sec. Max, Solder wave 260 $^{\circ}$ C Max, Soldering time 5 sec. Max. performed consecutively cooling process is required between 1st and 2nd soldering processes.

SURFACE MOUNT DEVICE LED Part No.: L-C191WDT-5A-U1 **REV:** A / 2 4. Lead-Free Soldering For Reflow Soldering : 1、Pre-Heat Temp: 150-180°C,120sec.Max. 2、Soldering Temp: Temperature Of Soldering Pot Over 230°C,40sec.Max. 3、Peak Temperature: 260°℃, 5sec. 4、Reflow Repetition: 2 Times Max. 5、Suggest Solder Paste Formula: 93.3 Sn/3.1 Ag/3.1 Bi/0.5 Cu For Soldering Iron (Not Recommended) : 1、Iron Tip Temp: 350°C Max. 2. Soldering Iron: 30w Max. 3、Soldering Time: 3 Sec. Max. One Time. For Dip Soldering : 1、Pre-Heat Temp: 150°C Max. 120 Sec. Max. 2、Bath Temp: 265°C Max. 3. Dip Time: 5 Sec. Max. 5. Drive Method Circuit model A Circuit model B (A)Recommended circuit. (B)The difference of brightness between LED's could be found due to the Vf-If characteristics of LED. DRAWING NO. : DS-74-17-0011G DATE : 2021-11-11 PAGE 13 of 13